

**VI TELEFILTER****Filter specification****TFS 460 C 1/3****Measurement condition**

Ambient temperature: 23 °C  
 Input power level: 0 dBm  
 Source impedance: 184 Ω || -0.33 pF  
 Load impedance: 184 Ω || -0.33 pF

**Construction and pin connection (see page 2)****Characteristics****Remark:**

Reference level for the relative attenuation  $a_{rel}$  of the TFS 460 C is the minimum of the pass band attenuation  $a_{min}$ . The minimum of the pass band attenuation  $a_{min}$  is defined as the insertion loss  $a_e$ . The centre frequency  $f_o$  is the arithmetic mean value of the upper and lower frequencies at the 3dB filter attenuation level relative to the insertion loss  $a_e$ . The nominal frequency  $f_N$  is fixed on 460 MHz without tolerance. The given values for the relative attenuation  $a_{rel}$  and for the group delay ripple have to be reached at the frequencies given below also if the centre frequency  $f_o$  is shifted due to the temperature coefficient of frequency  $TC_f$  in the operating temperature range and due to a production tolerance for the centre frequency  $f_o$

<b>D a t a</b>		<b>typ. value</b>		<b>tolerance / limit</b>	
<b>Insertion loss</b> (Reference level)	$a_e = a_{min}$	3	dB	max 5	dB
<b>Nominal frequency</b>	$f_N$	-		460	MHz
<b>Centre frequency</b>	$f_o$	460	MHz	-	
<b>Pass band ripple</b>					
$f_N \pm 10$ MHz		1	dB	max. 2	dB
<b>Relative attenuation</b> $a_{rel}$					
360 MHz ... 380 MHz		60	dB	min. 50	dB
405 MHz ... 425 MHz		> 40	dB	min. 40	dB
<b>Operating temperature range</b>			- 25 °C ... + 75 °C		
<b>Temperature coefficient of frequency</b>	TC	- 71	ppm/K		

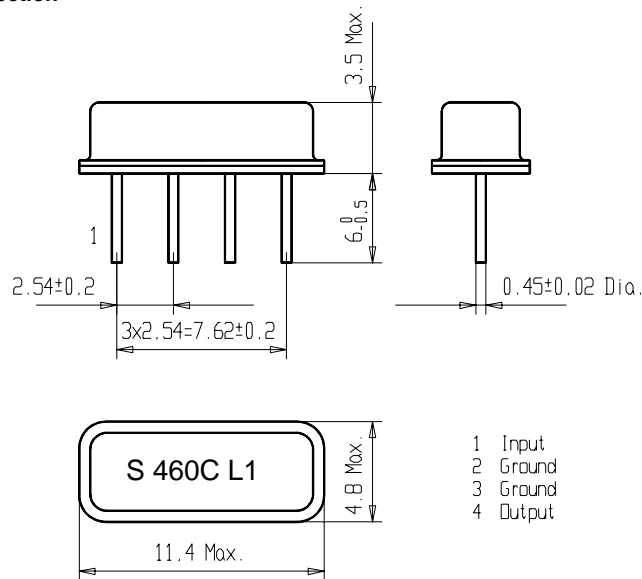
**Generated:****Checked / approved:**

VI TELEFILTER  
 Potsdamer Straße 18  
 D 14 513 TELTOW / Germany  
 Tel: (+49) 3328 4784-52 / Fax: (+49) 3328 4784-30  
 E-Mail: tft@telefilter.com

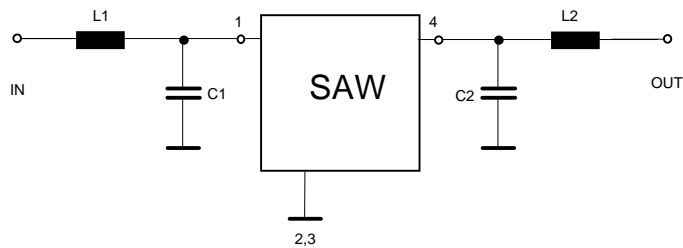
Vectron International, Inc.  
 267 Lowell Road  
 Hudson, NH 03051 / USA  
 Tel: (603) 598-0070 Fax: (603) 598-0075  
 E-Mail: vti@vtinh.com

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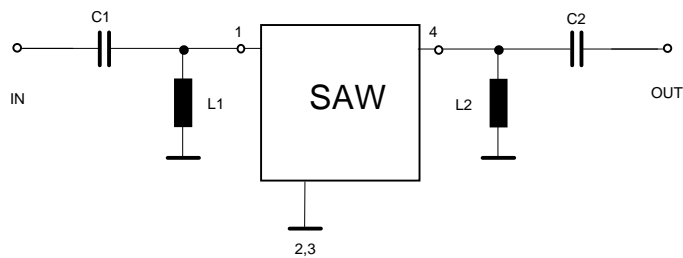
## Construction and pin connection



## 50 Ω test circuit 1 \*)



## 50 Ω test circuit 2 \*)



\*) Both circuits are possible, but the behavior of the first circuit differs slightly from the second one. The final test at Telefilter is carried out with the first circuit.

### Air reflow temperature conditions

#### 1st and 2nd air reflow profile

Name:	pre-heating periods	main-heating periods	peak temperature
Temperature:	150 °C - 170 °C	over 200 °C	255 °C ± 5 °C
Time:	60 sec. - 90 sec.	20 sec. - 25 sec.	

#### Chip-mount air reflow profile

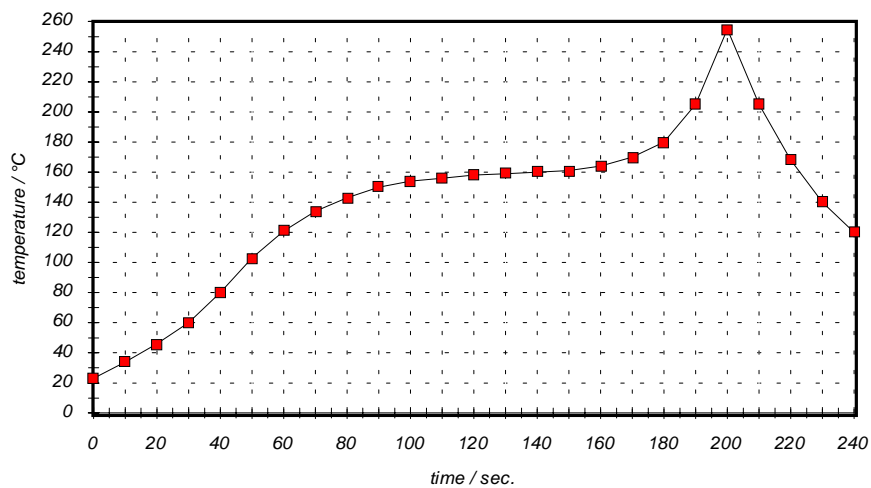


Table for temperature vs. time during the air reflow process

Tolerance of temperatures: ± 5 °C			
time / sec.	temperature / °C	time / sec.	temperature / °C
0	23	140	160
10	34	150	161
20	46	160	164
30	60	170	170
40	80	180	180
50	103	190	205
60	121	195	230
70	134	200	255
80	143	205	230
90	150	210	205
100	154	215	180
110	156	220	165
120	158	230	140
130	159	240	120